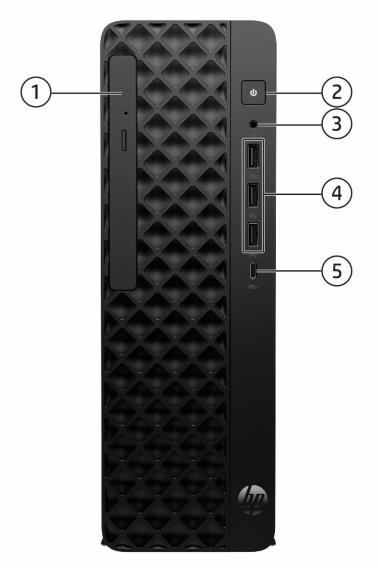
Overview

HP ProDesk 2 SFF G1i E Desktop PC



- 1. Slim-height Bay supporting an optical disk drive (optional)
- 2. Power Button
- 3. Combo jack, Headphone/ Microphone
- 4. (3) SuperSpeed USB 5Gbps signaling rate Ports¹
- 5. (1) USB-C 3.2 G2 (10G)

Not shown

- (1) PCI Express4.0 x16
- (1) PCI Express 3.0 x 1
- (1) M.2 for WLAN
- (1) M.2 2280 storage
- 1. SuperSpeed USB 5Gbps = USB3.2 Gen1

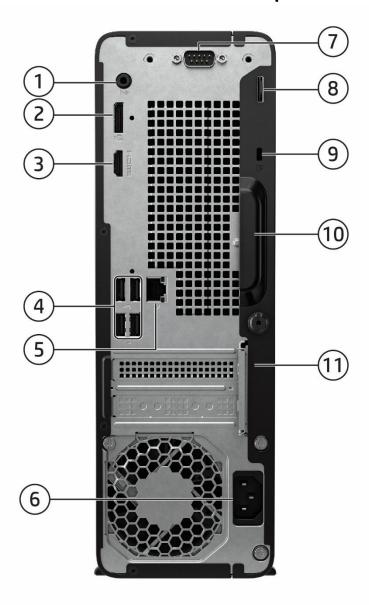
Bays

- (1) 3.5 internal HDD +bay (optional)
- (1) 9.5mm internal optical drive bay (optional)



Overview

HP ProDesk 2 SFF G1i E Desktop PC



- 1. Audio Line-out- retask as Line-in
- 2. DisplayPort 1.4a
- 3. HDMI 1.4b
- 4. (4) USB 2.0 ports
- 5. RJ-45 Network Connector

Not Shown

Parallel Port (Optional via PCIex1 slot) 4 Serial Port (Optional via PCIe slot)

- 6. Power Cord Connector
- 7. Serial port (option)
- 8. Padlock loop
- 9. Security cable lock slot
- 10. Integrated accessories cable lock
- 11. PCIE lock for Graphic Card

Overview

AT A GLANCE

- Windows 11 Pro 64, Win 11 Home 64, Windows 11 Home Single Language, or FreeDOS.
- Intel® H770 chipset supporting Intel® 13th or 14th processors¹ featuring Intel® UHD Graphics.
- Supports an optional discrete graphics card.
- Integrated 10/100/1000 Ethernet Controller or Realtek RTL8852BE-VT 802.11ax 2x2 Wi-Fi 6 + Bluetooth® 5.4 Wireless Card (802.11ax 2x2, supporting gigabit data rate), or Realtek RTL8852CE 802.11ax 2x2 Wi-Fi 6E + Bluetooth® 5.3 Wireless Card (802.11ax 2x2, supporting gigabit data rate).
- Up to 64GB DDR5-5600 Unbuffered Memory (UDIMM).
- Independent monitor support via DP and HDMI interfaces.
- TPM 2.0 support (firmware).
- Supports both Hard Disk Drives and SATA TLC / PCIe® NVMe™ M.2 SSD or PCIe® NVMe™ TLC M.2 SSD.
- 8 USB Ports (including 3 SuperSpeed USB 5Gbps ports, 1 USB-C 3.2 G2 (10G), and 4 USB 2.0 ports).
- 180W 90% HE power supply and 280W 92% HE power supply.
- Security cable lock supported (sold separately).
- Optional HP Care Packs available; terms and conditions vary by country; certain restrictions and exclusions apply¹.

1. HP Care Packs sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Standard Features and Configurable Modules

OPERATING SYSTEMS

Preinstalled Windows 11 Pro¹

Windows 11 Home - HP recommends Windows 11 Pro for Business¹

Windows 11 Home Single Language - HP recommends Windows 11 Pro for Business¹

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS*

Intel 13th Processors Intel® Core™ i3¹

CPU Intel Core i3-13100 4C 3.4GHz 3200MHz 60W (3.4GHz, turbo up to 4.5GHz, 12MB cache, 4 cores).

Intel® Core™ i51

CPU Intel Core i5-13400 10C 2.5GHz 3200MHz 65W (2.5GHz, turbo up to 4.6GHz, 20MB cache, 10 cores). CPU Intel Core i5-13500 14C 2.5GHz 3200MHz 65W (2.5GHz, turbo up to 4.8GHz, 24MB cache, 14 cores).

Intel® Core™ i71

CPU Intel Core i7-13700 16C 2.1GHz 3200MHz 65W (2.1GHz, Up to 5.2GHz with Intel® Turbo Boost², 30MB cache, 16 cores).

Intel 14th Processors

Intel® Core™ 300 with Intel UHD Graphics 710 (3.9 GHz P-core base frequency, 6 MB L3 cache, 2 P-cores, 4 threads).

Intel® Core™ i31

Intel® Core™ i3-14100 with Intel UHD Graphics 730 (3.5 GHz P-core base frequency, up to 4.7 GHz P-core Max Turbo frequency, 12 MB L3 cache, 4 P-cores, 8 threads).

Intel® Core™ i51

Intel® Core™ i5-14400 with Intel UHD Graphics 730 (1.8 GHz E-core base frequency, 2.5 GHz P-core base frequency, up to 3.5 GHz E-core Max Turbo frequency, up to 4.7 GHz P-core Max Turbo frequency, 20 MB L3 cache, 6 P-cores and 4 E-cores, 16 threads).

Intel® Core™ i5-14500 with Intel UHD Graphics 770 (1.9 GHz E-core base frequency, 2.6 GHz P-core base frequency, up to 3.7 GHz E-core Max Turbo frequency, up to 5.0 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 threads), supports Intel® vPro® Technology.

Intel® Core™ i71

Intel® Core™ i7-14700 with Intel UHD Graphics 770 (1.5 GHz E-core base frequency, 2.1 GHz P-core base frequency, up to 4.2 GHz E-core Max Turbo frequency, up to 5.3 GHz P-core Max Turbo frequency, 33 MB L3 cache, 8 P-cores and 12 E-cores, 28 threads), supports Intel® vPro® Technology.

1. Your product does not support Windows 8 or Windows 7, In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel 8th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com.

*NOTE: Not all processors are available; it varies by version.



Standard Features and Configurable Modules

CHIPSET

Intel® H770 Chipset

GRAPHICS

Integrated^{1,2}

Intel® UHD

Graphics 770

Graphics 730

Graphics 710

Discrete Graphics

AMD Radeon™ RX 6300 Graphics (2 GB GDDR6)

- 1. HD content required to view HD images.
- 2. Integrated Intel software is available on select models only and requires separately purchased projector, tv or computer monitor with an integrated or external receiver. External receivers connect to the projector, tv or computer monitor via a standard VGA, HDMI cable, also sold separately.

MEMORY

Both slots are customer accessible / upgradeable, Supports Dual Channel Memory

Form Factor	Туре	Maximum	# of Slots
Small Form Factor	DDR5 4800/5600	64 GB capacity	2 DIMM ¹
8GB DDR5-5600 UDIMM (1x86 8GB DDR5-4800 UDIMM (1x86	-		

16GB DDR5-5600 UDIMM (1x16GB) 16GB DDR5-4800 UDIMM (1x16GB)¹

16GB DDR5-5600 UDIMM (2x8GB)

16GB DDR5-4800 UDIMM (2x8GB)¹

32GB DDR5-5600 UDIMM (1x32GB)

32GB DDR5-4800 UDIMM (1x32GB)¹

32GB DDR5-5600 UDIMM (2x16GB)

32GB DDR5-4800 UDIMM (2x16GB)1

64GB DDR5-5600 UDIMM (2x32GB)

64GB DDR5-4800 UDIMM (2x32GB)1

- 1. Memory modules supporting data transfer rates up to 5600/MTs requires Intel® Core™ i5-1x600 or i7 CPUs, with other CPUs, memory supports data transfer rates up to 4800 MT/s. When select the WLAN card, the memory modules support data transfer rates up to 4400/MTs
- 2. Memory speed 5200 MT/s can be achieved when dual-rank (2R) memory UDIMMs when populated with the same part number.



Standard Features and Configurable Modules

STORAGE AND DRIVES

NOTE: Starting from November 1st, 2023, all shipments will require Windows to be installed when selecting a SSD. HDD can only be configured as additional data drives and not as the boot drive.

SATA3 - 3.5"

2TB 7200 RPM SATA Hard Disk Drive 1TB 7200 RPM SATA Hard Disk Drive

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

M.2 Solid State Drives

256GB M.2 2280 PCIe NVMe SSD 512GB M.2 2280 PCIe NVMe SSD 1TB M.2 2280 PCIe NVMe SSD 2TB M.2 2280 PCIe NVMe SSD 256GB M.2 2280 PCIe NVMe Three Layer Cell SSD¹ 512GB M.2 2280 PCIe NVMe Three Layer Cell SSD 1TB M.2 2280 PCIe NVMe Three Layer Cell SSD 2TB M.2 2280 PCIe NVMe Three Layer Cell SSD

1. Available on select skus only.

NOTE*: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows) of system disk is reserved for the system recovery software.

OPTICAL DISC DRIVES

DVD-ROM 9.5mm² DVD-Writer 9.5mm²

2. Optical drives are optional or add on features. HD-DVD disks cannot be played on this drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials.

NETWORKING/COMMUNICATIONS

Networking

Integrated 10/100/1000M GbE LAN

Network Adapter Intel FoxPond2 I226-T1 2.5GbE

Wi-Fi® and Bluetooth®

Realtek RTL8852BE-VT 802.11ax 2x2 Wi-Fi 6 + Bluetooth® 5.4 Wireless Card (802.11ax 2x2, supporting gigabit data rate)¹
Realtek RTL8852CE 802.11ax 2x2 Wi-Fi 6E + B Bluetooth® 5.3 Wireless Card (802.11ax 2x2, supporting gigabit data rate)¹

1. Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.



Standard Features and Configurable Modules

AUDIO/MULTIMEDIA

Realtek ALC3602-CG codec Integrated Hi-Definition Audio Combo Jack, Headphone / Microphone Audio Line-out- retask as Line-in

KEYBOARDS/POINTING DEVICES/BUTTONS AND FUNCTIONS KEYS

Keyboard

HP 125 v2 Antimicrobial Wired Keyboard (China only) HP 320K v2 Keyboard HP Bus Slim v2 Smart Card Wired Keyboard HP 655 v2 Black Wireless Keyboard/Mouse Kit

Mouse

HP Wired 320M Mouse HP Wired 125 Antimicrobial Mouse (China only) HP Black 125 Wired Mouse HP Wired 128 LSR Mouse HP USB Hardened Optical Wired Mouse

NOTE: Keyboards and mouse are optional or add-on features. A keyboard and mouse are required for this device. If you do not already have a keyboard and mouse, please refer to a list of compatible keyboards on the "Recommended Accessories" page.



Standard Features and Configurable Modules

PORTS

Front

Slim-height Bay - supporting an optical disk drive (option)

(3) SuperSpeed USB 5Gbps signaling rate

Combo Jack Microphone/Headphone

Power Button

(1) USB-C[©] 10Gbps

Not Shown

- (1) PCI Express 4.0 x 16
- (1) PCI Express 3.0 x 1
- (1) M.2 for WLAN
- (1) M.2 2280 storage

Rear

Audio Line-out-retask as Line-in

DisplayPort 1.4a

HDMI Port 1.4b

Standard lock slot

(4) USB 2.0 port

RJ-45 Network Connector

Power Cord Connector

Padlock loop

Integrated Accessories Cable Lock

Serial port (option)

Not Shown

- (1) Parallel Port (Optional via PCIex1 slot)
- (1) 4x Serial port (Optional via PCIex1 slot)1
- (1) PS/2 Port (Optional)
- 1. Available for selected regions

BAYS

- (1) 3.5" internal storage optional
- (1) 9.5mm internal optical drive bay optional



Standard Features and Configurable Modules

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Security and Protection

McAfee - MLS

HP Utilities and Support

HP Documentation HP Support Assistant

BTB

HP Setup Integrated OOBE (GDPR)

Hardware Enabling Drivers or software utility

HP System Event Utility

1. Free 1-year subscription of McAfee LiveSafe service included. Internet access required and not included. Subscription required after expiration.

POWER

Power Supply

180 W

EPA90 Power Supply

280W

EPA92 Power Supply

WEIGHT AND DIMENSIONS

(configured with 1 HDD and 1 ODD)

Chassis (W x D x H) 3.94 x 12.13 x 11.95 in (100 x 308 x 304 mm) (w/bezel)

System Weight 12.57 lbs / 5.7 kg*

*NOTE: Weight varies by configuration and component



Standard Features and Configurable Modules

UNIT ENVIRONMENTAL AND OPERATING CONDITIONS

General Unit Operating Guidelines

Environmental and Industry

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range Operating: 5° to 35° C¹

Non-operating: -30° to 60°1

Relative Humidity Operating: 15% to 80% (non-condensing at ambient)

Non-operating: 15% to 80% (non-condensing at ambient)

Maximum Altitude

Operating: 5,000 m

(unpressurized) Non-operating: 50,000 ft (15240 m)

1. Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.



Standard Features and Configurable Modules

Eco-Label Certifications & declarations System Configuration	may be labeled with one or more IT ECO declaration TUV ultra-low noise US ENERGY STAR® EPEAT Gold* or EPEAT Silver** registration status in your countr TCO Certified China Energy Conservation Prog Clean Energy Certificates (CEL) Minimum Energy Performance S Ukraine energy Commission Regulation (EC) No	of these marks: egistered in the United State y. gram (CECP) standard (Korea/Vietnam/A/ 617/2013 (ErP Lot 3) ergy Consumption and Decl	Z MEPS) ared Noise Emissions data for the
Energy Consumption (in accordance with US ENERGY STAR® test method)	Desktop model is based on a "Tyl	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	12.46W	12.51W	12.40W
Normal Operation (Long idle)	10.16W	10.22W	10.02W
Sleep	1.76W	1.75W	1.76W
Off	0.38W	0.41W	0.41W
	not offer ENERGY STAR® compliant c		
		enerator on HP's 3rd party option	pply, and a Microsoft Windows® on store for solar generator accessories
Heat Dissipation*	operating system. Search keyword g	enerator on HP's 3rd party option	
Normal Operation (Short idle)	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr	enerator on HP's 3rd party options.	on store for solar generator accessories
	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz	enerator on HP's 3rd party options. 230VAC, 50Hz	on store for solar generator accessories 100VAC, 50Hz
Normal Operation (Short idle) Normal Operation (Long idle)	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr	enerator on HP's 3rd party options. 230VAC, 50Hz 42.66 BTU/hr	100VAC, 50Hz 42.28 BTU/hr
Normal Operation (Short idle)	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr 6.00 BTU/hr 1.30 BTU/hr	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr 5.97 BTU/hr 1.40 BTU/hr	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr 6.00 BTU/hr
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr 6.00 BTU/hr 1.30 BTU/hr NOTE: Heat dissipation is calculated one hour. Sound Power	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr 5.97 BTU/hr 1.40 BTU/hr	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr 6.00 BTU/hr 1.40 BTU/hr assuming the service level is attained for
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Declared Noise Emissions	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr 6.00 BTU/hr 1.30 BTU/hr NOTE: Heat dissipation is calculated one hour.	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr 5.97 BTU/hr 1.40 BTU/hr	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr 6.00 BTU/hr 1.40 BTU/hr
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr 6.00 BTU/hr 1.30 BTU/hr NOTE: Heat dissipation is calculated one hour. Sound Power	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr 5.97 BTU/hr 1.40 BTU/hr	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr 6.00 BTU/hr 1.40 BTU/hr assuming the service level is attained for
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr 6.00 BTU/hr 1.30 BTU/hr NOTE: Heat dissipation is calculated one hour. Sound Power (L _{WAd} , bels)	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr 5.97 BTU/hr 1.40 BTU/hr	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr 6.00 BTU/hr 1.40 BTU/hr assuming the service level is attained for Sound Pressure (L _{pAm} , decibels)
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured – Idle	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr 6.00 BTU/hr 1.30 BTU/hr NOTE: Heat dissipation is calculated one hour. Sound Power (L _{WAd} , bels) 3.2	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr 5.97 BTU/hr 1.40 BTU/hr	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr 6.00 BTU/hr 1.40 BTU/hr essuming the service level is attained for Sound Pressure (L _{pAm} , decibels) 19.7
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured – Idle Fixed Disk – Random writes Optical Drive – Sequential	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr 6.00 BTU/hr 1.30 BTU/hr NOTE: Heat dissipation is calculated one hour. Sound Power (L _{WAd} , bels) 3.2 3.3 4.5 This product can be upgraded, pofeatures and/or components con Spare parts are available through	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr 5.97 BTU/hr 1.40 BTU/hr based on the measured watts, a	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr 6.00 BTU/hr 1.40 BTU/hr assuming the service level is attained for (L _{pAm} , decibels) 19.7 20.7 38.2 fe by several years. Upgradeable
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured – Idle Fixed Disk – Random writes Optical Drive – Sequential reads	operating system. Search keyword g at http://www.hp.com/go/option 115VAC, 60Hz 42.49 BTU/hr 34.65 BTU/hr 6.00 BTU/hr 1.30 BTU/hr NOTE: Heat dissipation is calculated one hour. Sound Power (LwAd, bels) 3.2 3.3 4.5 This product can be upgraded, pofeatures and/or components con	230VAC, 50Hz 42.66 BTU/hr 34.85 BTU/hr 5.97 BTU/hr 1.40 BTU/hr based on the measured watts, a	100VAC, 50Hz 42.28 BTU/hr 34.17 BTU/hr 6.00 BTU/hr 1.40 BTU/hr essuming the service level is attained for Sound Pressure (L _{pAm} , decibels) 19.7 20.7 38.2 fe by several years. Upgradeable clude:



Standard Features and Configurable Modules

	Mercury greater the1ppm by weight			
	Cadmium greater than 20ppm by weight			
	Battery size: CR2032			
	Battery type: Lithium			
Additional Information	•	ompliance with the Restrictions of Hazardous Substance	s (RoHS) directive -	
	2011/65/EC.			
		lesigned to comply with the Waste Electrical and Electro	nic Equipment	
	(WEEE) Directive – 20	•		
	• This product is in compliance with California Proposition 65 (State of California; Safe Drinkin			
	Water and Toxic Enfo	orcement Act of 1986).		
	This product is in co	ompliance with the IEEE 1680.1 (EPEAT) standard at the	<silver> level, see</silver>	
	http://www.epeat.ne	et e		
	 Plastics parts weight 	hing over 25 grams used in the product are marked per I	S011469 and	
	IS01043.			
	 This product contain 	ns 28.2% post-consumer recycled plastic (by wt.)		
	This product is 91.7	7% recycle-able when properly disposed of at end of life		
Packaging Materials	External:	PAPER/Corrugated	540 g	
	Internal:	PAPER/Molded Pulp	350 g	
		PLASTIC/Polyethylene low density - LDPE	30 g	
Material Usage	This product does no	t contain any of the following substances in excess of re		
		(refer to the HP General Specification for the Environment at		
		http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):		
	• Asbestos	npinio, geodateitizensinp, environnent, par, gseipar,		
	Certain Azo Colorar	nts		
		l Flame Retardants – may not be used as flame retardan	ts in plastics	
	Cadmium	That is the caracter and its a	to in plastics	
	Chlorinated Hydroc	arhons		
	Chlorinated Paraffin			
	Formaldehyde			
	Halogenated Diphe	nyl Methanes		
	Lead carbonates an			
	Lead and Lead com			
	Mercuric Oxide Batt	•		
		ust not be used on the external surface designed to be fr	oguently handled or	
	carried by the user.	ast not be used on the external surface designed to be n	equently nanated of	
	Ozone Depleting Su	ihstances		
	Polybrominated Big			
	 Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs) 			
	Polybronninated Bip Polychlorinated Bip			
	Polychlorinated Tel			
			rlyaging has been	
		PVC) – except for wires and cables, and certain retail par	ckaying nas been	
	voluntarily removed from most applications.			
	Radioactive Substa Tributul Tip (TDT) Tributul Tip (TD			
	• iributyl iin (iBI), i	Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)		



Standard Features and Configurable Modules

Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
	• Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
	• Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
	Design packaging materials for ease of disassembly.
	Maximize the use of post-consumer recycled content materials in packaging materials.
	• Use readily recyclable packaging materials such as paper and corrugated materials.
	 Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
	Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_1 4K_Certificate.pdf and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

SERVICE AND SUPPORT

On-site Warranty¹: Available three-year (3-3-3) or one-year (1-1-1) limited warranty (varies by country) delivers on-site, next business day² service for parts and labor and complimentary limited technical support³. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Service⁴. To choose the right level of service for your HP product, visit HP Care Pack Central: http://www.hp.com/qo/cpc.

- 1. Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.
- 2. On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
- 3. Technical support applies only to HP-configured and third-party HP qualified hardware and software.
- 4. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

GRAPHICS



Technical Specifications - Graphics

GRAPHICS

Intel® UHD Graphics (integrated)		
Graphics Controller	Integrated	
DisplayPort™	Multimode capable; supports HDCP, Display Port Audio, HBR2 link rates and Multi-Stream Technology for a maximum of 2 displays connected to any output controlled by Intel® Graphics.	
HDMI (on board/optional)	Supports HDMI 1.4 features Supports HDCP 2.3 Supports audio over HDMI	
Memory	The actual amount of maximum graphics memory can be >4GB. System memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.	
Maximum Color Depth	up to 16 bits/color	
Graphics/Video API Support	HEVC 10b Enc/12b Dec HW VP9 10b Dec HW HDR Rec. 2020 DX12	
Max. Resolution (HDMI)	4K x 2K@30Hz	
Max. Resolution (DP)	4K x 2K@30Hz	

Note: The actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

Note: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP Only supported on displays connected to the external DisplayPort™ connector.

AMD Radeon™ RX 6300 2GB GDDR6 Graphics card

Engine Clock Base: 1512 Mhz Boost: 2040 Mhz

Memory Size / Width 2GB / 32bits

Graphic Memory Type / Clock 512Mx 32 GDDR6, 1 pcs / 16Gbs

 Max. Resolution (HDMI)
 7680x4320@60Hz

 Max. Resolution (DP)
 7680x4320@120Hz

Multi Display Support 2 displays

HDCP Compliance Yes

Rear I/O connectors (bracket) HDMIx1+DPx1 (LP)

Cooling (active/passive) Active **Total power consumption (W)** 57W

Form-factor X:160.2mm/Y:68.9mm/Z: 22.6mm PCB with single slot



Technical Specifications – Storage

STORAGE

NOTE: Starting from November 1st, 2023, all shipments will require Windows to be installed when selecting a SSD. HDD can only be configured as additional data drives and not as the boot drive.

HP 2TB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive*

Capacity 2TB

Rotational Speed 7,200 rpm **Interface** SATA 6Gb/s NCQ

Buffer Size 64 MB

 Logical Blocks
 3,907,029,168

 Seek Time
 Read: <8.5 ms</td>

Write: <9.5 ms

 Height
 1.028 in/26.11 mm

 Width
 4.0 in/101.6 mm

Operating Temperature 32° to 140° F (0° to 60° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

1TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 1TB

Rotational Speed 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 32 MB

 Logical Blocks
 1,953,525,168

 Seek Time
 Read: <8.5 ms</td>

 Write: <9.5 ms</th>

Full-Stroke: 21 ms

Height 1 in/2.54 cm

Width Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.



Technical Specifications – Storage

256GB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight < 10q Capacity 256GB Height 2.38mm Length 80mm Width 22mm PCIE Gen3x4 Interface **Maximum Sequential Read** Up to 2700MB/s **Maximum Sequential Write** Up to 1000MB/s **Logical Blocks** 500.118.192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

512GB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight < 10q Capacity 512GB Height 2.38mm Length 80mm Width 22mm Interface PCIE Gen3x4 **Maximum Sequential Read** Up to 2900MB/s **Maximum Sequential Write** Up to 1100MB/s

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

1,000,215,216

Features APST; ASPM L1.2; NVME spec 1.2

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

1TB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight < 10q Capacity 1TB 2.3mm Height Length 80mm Width 22mm Interface PCIE NVMe **Maximum Sequential Read** Up to 2900MB/s **Maximum Sequential Write** Up to 1100MB/s **Logical Blocks** 2,000,409,2<u>64</u>

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features Pyrite



Logical Blocks

Technical Specifications – Storage

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

2TB M.2 2280 PCIe NVMe Three Layer Cell SSD

Capacity 2TB

Interface PCIE Gen4x4

Minimum Sequential Read 6400 MB/s ±10%

Minimum Sequential Write 5000 MB/s ±10%

Logical Blocks 4,000,797,360

Features TRIM; L1.2; Pyrite 2.0

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

256GB M.2 2280 PCIe NVMe SSD

Drive Weight < 10g
Capacity 256GB
Height 2.38mm
Length 80mm
Width 22mm

InterfacePCIE Gen4x4Minimum Sequential ReadUp to 1600MB/sMinimum Sequential WriteUp to 780MB/sLogical Blocks500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

512GB M.2 2280 PCIe NVMe SSD

Drive Weight < 10g
Capacity 512GB
Height 2.38mm
Length 80mm
Width 22mm

InterfacePCIE Gen4x4Minimum Sequential ReadUp to 1600MB/sMinimum Sequential WriteUp to 860MB/sLogical Blocks1,000,215,216

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2



Technical Specifications – Storage

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

1TB M.2 2280 PCIe NVMe SSD

Capacity 1TB

InterfacePCIE Gen4x4Minimum Sequential Read2200 MB/s ±10%Minimum Sequential Write1600 MB/s ±10%Logical Blocks2,000,409,264FeaturesTRIM; L1.2

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

2TB M.2 2280 PCIe NVMe SSD

Capacity 2TB

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.



Technical Specifications — Optical Disc Drives

OPTICAL DISC DRIVES

HP 9.5mm Slim DVD-ROM Drive

Height 9.5 mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Dimensions (W x H x D) 5.04 x 0.37 x 5.0 in (128 x 9.5 x 127 mm) without bezel

Weight (max) Up to 0.31 lb (140g) without bezel

DVD+R/-R/+RW/ **Read Speeds**

> -RW/+R DL /-R DL Up to 8X DVD-ROM Up to 8X CD-ROM, CD-R Up to 24X CD-RW Up to 24X

Access time

(typical reads, including

Random: DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical) settling) Full stroke: DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)

Power Source Slimline SATA DC power receptacle

> DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

Environmental conditions

Temperature 41° to 122° F (5° to 50° C)

(operating - non-condensing) Relative Humidity 10% to 80%

Maximum Wet Bulb Temperature 84° F (29° C)

HP 9.5mm Slim DVD Writer Drive

Height 9.5 mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Dimensions (W x H x D) 5.04 x 0.37 x 5.0 in (128 x 9.5 x 127 mm) without bezel

Weight (max) Up to 0.31 lb (140 g) Without bezel

Write Speeds DVD-R DL - Up to 6X

> DVD+R - Up to 8X DVD+RW - Up to 8X DVD+R DL - Up to 6X DVD-R - Up to 8X DVD-RW - Up to 6X CD-R - Up to 24X CD-RW - Up to 10X

DVD-RW. DVD+RW - Up to 8X Read Speeds

> DVD-R DL, DVD+R DL - Up to 8X DVD+R, DVD-R - Up to 8X

DVD-ROM DL, DVD-ROM - Up to 8X CD-ROM, CD-R - Up to 24X

CD-RW - Up to 24X

(typical reads, including

Access time

Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical) Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)

settling) Stop Time 6 seconds (typical)



Technical Specifications — Optical Disc Drives

Power Source Slimline SATA DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

Environmental conditions Temperature 41° to 122° F (5° to 50° C)

(operating - non-condensing) Relative Humidity 10% to 80%

Maximum Wet Bulb Temperature 84° F (29° C)



Technical Specifications – Audio

HIGH DEFINITION AUDIO

Sampling

Type Integrated

HD Stereo Codec Realtek ALC3602-CG codec
Audio I/O Ports Support the combo jack for CTIA

Playback multi-streaming can be enabled in the audio control UI to allow independent audio

Multi-streaming Capable streams to output to the front and rear jacks or integrated speaker.

HD Audio Codec ALC3602-CG

DAC supports 16bit ~ 24 bit, sampling rate 44.1K/ 48K/ 96K/ 192K Hz ADC supports 16bit ~ 24 bit, sampling rate 44.1K/ 48K/ 96K/ 192K Hz

Wavetable Syntheses Yes
Analog Audio Yes
of Channels on Line-Out Stereo

External Speaker Jack* 2W class D mono amplifier only. External speakers must be powered externally.



Technical Specifications - Power

POWER SUPPLY

Operating Voltage Range 90 – 264 VAC
Rated Voltage Range 100-240V AC
Rated Line Frequency 50/60 HZ
Operating Line Frequency 47 – 63 Hz
Rated Input Current 180 W: <2.3A
280W: <3.3A

280W: <3.3A 400W: <5.2A 500 W: <6A

Rated Input Current with Energy

Efficient* Power Supply

180W active PFC / Efficiency at 115Vac

80PLUS Gold certified 87/90/87% at 20/50/100% load

Efficiency at 230Vac

90/92/89% at 20/50/100% load Which meet 80PLUS Gold

280W active PFC / Efficiency at 115Vac

80PLUS Platinum certified 90/92/89% efficient at 20/50/100% load

Efficiency at 230Vac

91/93/90% at 20/50/100% load Which meet 80PLUS Gold

DC Output +12 V

Current Leakage (NFPA 99: 2102)

Less than 500 microamps of leakage current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility

or that contact patients in normal use. Per section 10.3.5.1.

Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a

patient care facility or that contact patients in normal use. Per section 10.3.5.1.

Power Supply Fan 180 W: 70*25mm (linear type)

280W/400W/500W: 70x25mm (PWM type)



Technical Specifications – Weights and Dimensions

WEIGHTS AND DIMENSIONS

Chassis (W x D x H) 3.94 x 12.13 x 11.95 in (100 x 308 x 304 mm) (w/ bezel)

System Volume 9L

 System Weight*
 12.57 lbs / 5.7 kg

 Packaged
 15.67 x 7.87 x 19.65 in

 (H x W x D)
 398 x 200 x 499 mm

 Shipping Weight*
 16.36 lb / 7.42 kg

 Palletization
 12-units per layer

 Profile
 5 layer max

60 per pallet Footprint (HxWxD) 83.46 x 39.37 x 47.24 in (2120 x 1000 x 1200 mm)

*NOTE: Weight varies by configuration and component



Technical Specifications – Networking

NETWORKING

10/100/1000 Integrated NIC	
Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
Performance Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K
Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status

ntel I226-T1 2.5GbE Ethernet Network Adapter		
Connector	RJ-45	
System Interface	PCI (Intel proprietary) + SMBus	
Data rates supported	1. 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 2. 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 3. 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3 clauses 40) 4. 2.5 Gbit/s operation (2.5GBASE-T; IEEE 802.3bz Clause 126) 5. Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 & 100 Mbit/s	
IEEE Compliance	IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet) IEEE 802.3i 10BASE-T IEEE 802.3u 100BASE-TX IEEE 802.3ab 1000BAE-T IEEE 802.3bz 2.5GBASE-T	
Performance	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling(Hash Mode Only) Jumbo Frame 9K	



Power consumption	Cable Disconnection: 25mW 100Mbps Full Run: 450mW 1000Mbp Full Run: 1000mW 2500Mbp Full Run: 4500mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW
Power	ACPI compliant – multiple power modes
Management	Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
Management Interface	Auto MDI/MDIX Crossover cable detection
IT Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status

Wireless LAN Standards ¹	IEEE 802.11a
WIFELESS LAN Standards	IEEE 802.11b
	IEEE 802.11g IEEE 802.11n
	IEEE 802.1111
	IEEE 802.11ax
	IEEE 802.11d
	IEEE 802.11e
	IEEE 802.11h
	IEEE 802.11i
	IEEE 802.11k
	IEEE 802.11r
	IEEE 802.11v
Interoperability	Wi-Fi certified modules
Frequency Bands	
	802.11b/g/n/ax
	• 2.402 – 2.482 GHz
	802.11a/n/ac/ax
	• 4.9 – 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 – 5.35 GHz
	• 5.47 – 5.725 GHz
	• 5.825 – 5.850 GHz
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11n: max 300Mbps
	• 802.11ac: max 866.7Mbps
	• 802.11ax: max 1201Mbps



Modulation	Direct Sequence Spread Spectrum, OFDM,
Modulation	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
Security ²	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ³	• 802.11b: +18.5dBm minimum • 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum • 802.11n HT20(2.4GHz): +15.5dBm minimum • 802.11n HT40(2.4GHz): +14.5dBm minimum • 802.11n HT20(5GHz): +15.5dBm minimum • 802.11n HT40(5GHz): +14.5dBm minimum • 802.11ac VHT80(5GHz): +11.5dBm minimum • 802.11ac VHT80(5GHz): +10dBm minimum • 802.11ax HE40(2.4GHz): +10dBm minimum
Power Consumption	 Transmit mode: 2.5 W Receive mode: 2 W Idle mode (PSP) 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connected Standby/Modern Standby: 10mW Radio disabled: 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ⁴	802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum *802.11ax, MCS11(HE40): -57dBm maximum *802.11ax, MCS11(HE80): -54dBm maximum



Antenna type	High efficiency antenna with spatial diversity. Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications	
Form Factor	PCI-Express M.2 MiniCard	
Dimensions	1. Type 2230: 2.4 x 22.0 x 30.0 mm	
Weight	1. Type 2230: 2.8g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating: 14° to 158° F (–10° to 70° C) Non-operating: –40° to 176° F (–40° to 80° C)	
Humidity	Operating: 10% to 90% (non-condensing) Non-operating: 5% to 95% (non-condensing)	
Altitude	Operating: 0 to 10,000 ft (3,048 m) Non-operating: 0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber – Radio OFF; LED OFF – Radio ON	
HP Integrated Module with Bluet	ooth® 4.0/4.1/4.2/5.0/5.1/5.2/5.3/5.4 Wireless Card Technology	
Bluetooth® Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3/5.4 Wireless Card Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.	
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW	
Bluetooth® Software Supported Link Topology	Microsoft Windows Bluetooth Software	
Power Management	Microsoft Windows ACPI, and USB Bus Support	
Certifications	FCC (47 CFR) Part 15C/E, Section 15.247, 15.249 ETSI 300 328, ETSI 301 893	
Bluetooth® Profiles Supported	Bluetooth 4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising	



Technical Specifications – Networking

LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan Bluetooth 4.2 ESR08 Compliance LE Secure Connection-Basic/Full LE Privacy 1.2 -Link Laver Privacy LE Privacy 1.2 - Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) Bluetooth 5.1 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range

Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs.

- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



^{1.} Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Realtek RTI 8852CF 902 11av	x 2x2 Wi-Fi 6E + Bluetooth® 5.3 Wireless Card
(802.11ax 2x2, supporting gig	
Wireless LAN Standards ¹	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11b IEEE 802.11t IEEE 802.11t IEEE 802.11h IEEE 802.11i IEEE 802.11k
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n/ax • 2.402 – 2.482 GHz 802.11a/n/ac/ax • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz • 5.955 – 6.415 GHz • 6.435 – 6.515 GHz • 6.535 – 6.875 GHz
Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac: MCS0 ~ MCS9, (20MHz, 40MHz, ,80MHz & 160MHz) 802.11ax: MCS0 ~ MCS11, (20MHz, 40MHz, ,80MHz & 160MHz)
Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
Security ²	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 (personal) certification IEEE 802.11i WAPI EAP
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points



0.1.10	002.44147 ID		
Output Power ³	• 802.11b: +17dBm minimum		
	• 802.11g: +16dBm minimum		
	• 802.11a: +17dBm minimum • 802.11n HT20(2.4GHz): +14dBm minimum		
	• 802.11n HT40(2.4GHz): +14dBit minimum		
	• 802.11n HT20(5GHz): +14dBm minimum		
	• 802.11n HT40(5GHz): +13dBm minimum		
	• 802.11ac VHT80(5GHz): +10dBm minimum		
	• 802.11ac VHT160(5GHz): +10dBm minimum		
	• 802.11ax HE40(2.4GHz): +12dBm minimum		
	• 802.11ax HE80(5GHz): +10dBm minimum		
	• 802.11ax HE160(5GHz): +10dBm minimum		
	• 802.11ax HE80(6GHz): +10dBm minimum		
	• 802.11ax HE160(6GHz): +10dBm minimum		
Power Consumption	• Transmit mode: 2.5 W		
	Receive mode: 2 W		
	• Idle mode (PSP) 180 mW (WLAN Associated)		
	• Idle mode: 50 mW (WLAN unassociated)		
	Connected Standby/Modern Standby: 10mW		
	• Radio disabled: 8 mW		
Power Management	ACPI and PCI Express compliant power management		
-	802.11 compliant power saving mode		
Receiver Sensitivity ⁴	• 802.11b, 1Mbps: -93.5dBm maximum		
-	• 802.11b, 11Mbps: -84dBm maximum		
	• 802.11a/g, 6Mbps: -86dBm maximum		
	• 802.11a/g, 54Mbps: -72dBm maximum		
	• 802.11n, MCS07: -67dBm maximum		
	• 802.11n, MCS15: -64dBm maximum		
	• 802.11ac, MCS0(VHT80): -84dBm maximum		
	• 802.11ac, MCS9(VHT80): -59dBm maximum		
	• 802.11ac, MCS9(VHT160): -58.5dBm maximum		
	• 802.11ax, MCS11(HE40): -57dBm maximum		
	• 802.11ax, MCS11(HE80): -54dBm maximum		
	• 802.11ax, MCS11(HE160): -53.5dBm maximum		
Antenna type	High efficiency antenna with spatial diversity		
	Two embedded tri-band 2.4/5/6 GHz antennas are provided to the card to support WLAN		
	MIMO communications and Bluetooth communications		
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm		
Weight	1. Type 2230: 2.8g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating: 14° to 158° F (–10° to 70° C)		
•	Non-operating: –40° to 176° F (–40° to 80° C)		
Humidity	Operating: 10% to 60% (non-condensing)		
···uiiiuity	Non-operating: 5% to 95% (non-condensing)		
Altitude	Operating: 0 to 10,000 ft (3,048 m)		
	Non-operating: 0 to 50,000 ft (15,240 m)		
	N/A		
LED Activity	I N/A		



HP Integrated Module with BI	uetooth® 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card Technology			
Bluetooth® Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)			
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)			
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.			
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW			
Bluetooth® Software Supported Link Topology	Microsoft Windows Bluetooth Software			
Power Management	Microsoft Windows ACPI, and USB Bus Support			
Certifications	FCC (47 CFR) Part 15C/E, Section 15.247, 15.249, 15.407 ETSI 300 328, ETSI 301 893, ETSI 303 687			
Bluetooth® Profiles Supported	Bluetooth 4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan Bluetooth 4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 - Link Layer Privacy LE Privacy 1.2 - Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) Bluetooth 5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range Windows Bluetooth profiles support Bluetooth 5.3			



Periodic Advertisement interval
Encryption key size control enhancements

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



After-Market Options (availability may vary by region)

AFTER MARKET OPTIONS

<u>Type</u>	<u>Description</u>	<u> Part #</u>
Memory	HP 8GB DDR5-5600 DIMM	A9TF0AA
	HP 16GB DDR5-5600 DIMM	A9TF1AA
	HP 32GB DDR5-5600 DIMM	A9TF3AA
Storage	HP PCIe Gen 4 NVME TLC M.2 512GB SSD	406L8AA
	HP PCIe Gen 4 NVME TLC M.2 1TB SSD	406L7AA
	HP 1TB 7200rpm SATA 6Gb/s 3.5" Hard Drive	QK555AA
Graphics	AMD Radeon RX 6300 2GB GDDR6 DP+HDMI	7Y6P7AA
Networking	Intel I226-T1 2.5GbE Ethernet Network Adapter	9P1U8AA
Security	HP Business PC Security Lock V3 Kit	3XJ17AA
Security	HP Keyed Cable Lock 10mm kit	T1A62AA
	HP Master Keyed Cable Lock 10mm	T1A63AA
	HP Combination Standard Cable Lock	TOY15AA
	HP Essential Combination Lock	TOY16AA
	<u> </u>	
Cables/Adapters	HP HDMI Standard Cable Kit	T6F94AA
•	HP USB to Serial Port Adapter	J7B60AA
	HP PCIe x1 Parallel Port Card	N1M40AA
	JL	
Input	HP Business Slim v2 Smart Card USB Keyboard	A71J9AA
•	HP 125 G2 Wired Keyboard	AY2Y7AA
	HP 125 Wired Mouse	265A9AA
	HP 128 Laser Wired Mouse	265D9AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP 320K G2 Wired Keyboard	9SR37UT
	HP Wired Desktop 320MK G2 Mouse and Keyboard Combo	9SR36UT
	HP 655 Wireless Keyboard and Mouse Combo G2	4R009UT
	HP 405 Multi-Device Wired Backlit Keyboard	7N7C1AA
	HP 455 G2 Programmable WRLS USB Keyboard	B08ZDAA
	HP 475 Dual-Mode Wireless Keyboard	7N7B9AA
		15
Others	HP S101 Speaker bar	5UU40AA
	HP Z G3 Conferencing Speaker Bar wStand	647Y2AA



Change Log

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Date of change:	Version History:		Description of change:	
January 17, 2025	From v1 to v2	Correction	DDR4 corrected to DDR5 in Memory section	
January 21, 2025	From v2 to v3	Removal	NECC word removed from Memory section	
March 28, 2025	From v3 to v4	Correction	ion Maximum of displays changed to 2 in DisplayPort in Graphics section	
April 15, 2025	From v4 to v5	Correction	Internal Speaker values corrected to none.	
June 12, 2025	From v5 to v6	Addition	TCO Certification added to Environmental table	
July 10, 2025	From v6 to v7	Correction	High-definition audio table values corrected	
July 24, 2025	From v7 to v8	Correction	All M.2 2280 PCIe NVMe SSD´s interface and speed based corrected to PCIE Gen4x4 and minimum sequential read/write respectively	
	From v8 to v9			
	From v9 to v10			
	From v10 to v11			
	From v11 to v12			

